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TITLE:  28 LD PDIP		DOCUMENT NO: 98ASB42390B	REV: F
		STANDARD: NON-JEDEC	
		SOT117-4	01 APR 2016



NOTES:

1. POSITIONAL TOLERANCE OF LEADS, SHALL BE WITHIN 0.25 MM (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
2. DIMENSION TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION DOES NOT INCLUDE MOLD FLASH.
4. 710-01 OBSOLETE, NEW STD 710-02.
5. CONTROLLING DIMENSION: INCH

DIM	INCH		MILLIMETER		DIM	INCH		MILLIMETER	
	MIN	MAX	MIN	MAX		MIN	MAX	MIN	MAX
A	1.435	1.465	36.45	37.21					
B	0.540	0.560	13.72	14.22					
C	0.155	0.200	3.94	5.08					
D	0.014	0.022	0.36	0.56					
F	0.040	0.060	1.02	1.52					
G	0.100 BSC		2.54 BSC						
H	0.065	0.085	1.65	2.16					
J	0.008	0.015	0.20	0.38					
K	0.115	0.135	2.92	3.43					
L	0.600 BSC		15.24 BSC						
M	0°	15°	0°	15°					
N	0.020	0.040	0.51	1.02					

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